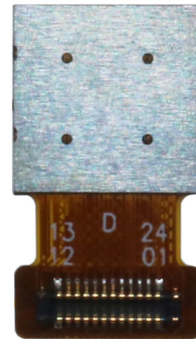


YDS-KG7-V3F V4.2

5MP OmniVision OV5648 MIPI Interface Fixed Focus Camera Module



Front View



Back View

Specifications

Camera Module No.	YDS-KG7-V3F V4.2
Resolution	5MP
Image Sensor	OV5648
Sensor Type	1/4"
Pixel Size	1.4 um x 1.4 um
EFL	3.20 mm
F.NO	2.80
Pixel	2592 x 1944
View Angle	70.0°(DFOV) 58.6°(HFOV) 45.3°(VFOV)
Lens Dimensions	8.50 x 8.50 x 4.92 mm
Module Size	15.31 x 8.50 mm
Module Type	Fixed Focus
Interface	MIPI
Auto Focus VCM Driver IC	None
Lens Model	YDS-LENS-M5182
Lens Type	650nm IR Cut
Operating Temperature	-30°C to +70°C
Mating Connector	AXE524124



YDS-KG7-V3F V4.2

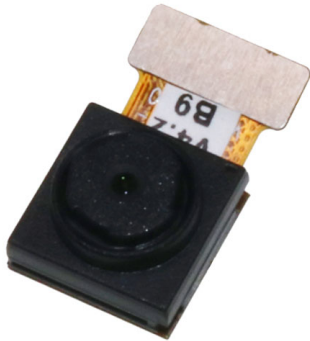
5MP OmniVision OV5648 MIPI Interface Fixed Focus Camera Module



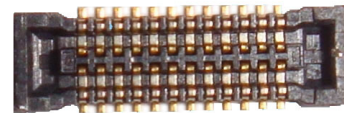
Top View



Side View

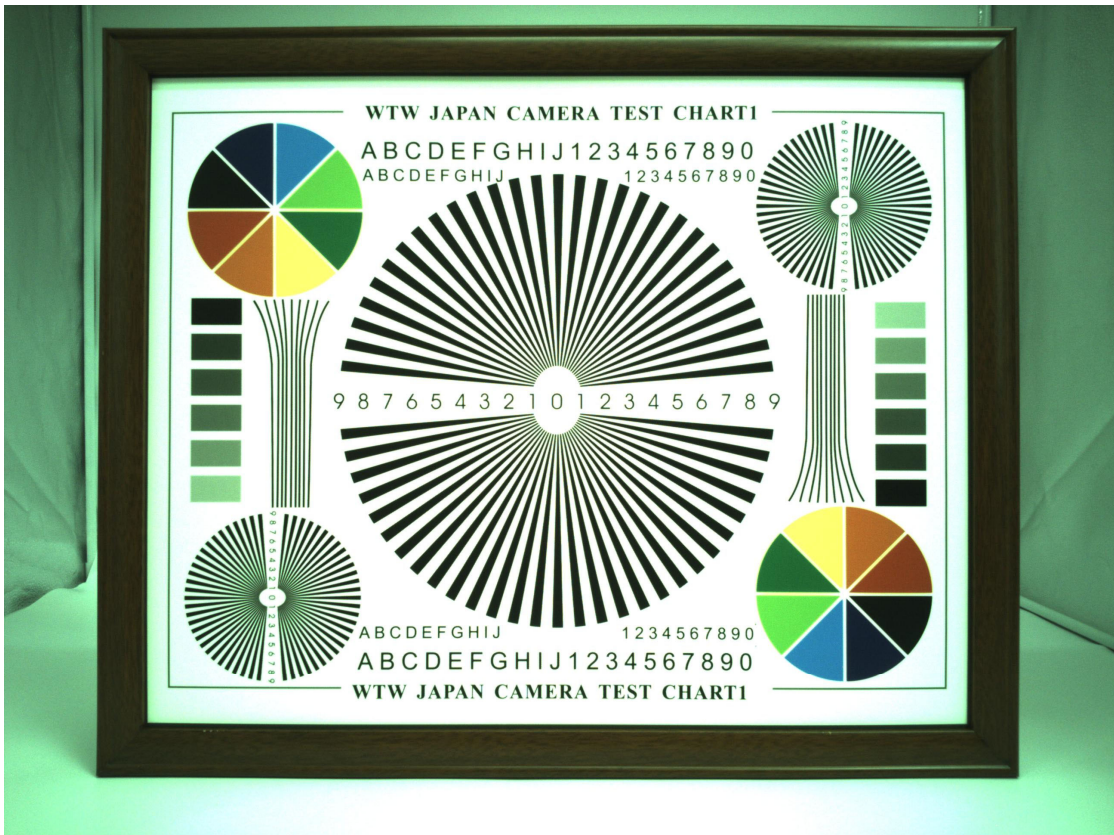
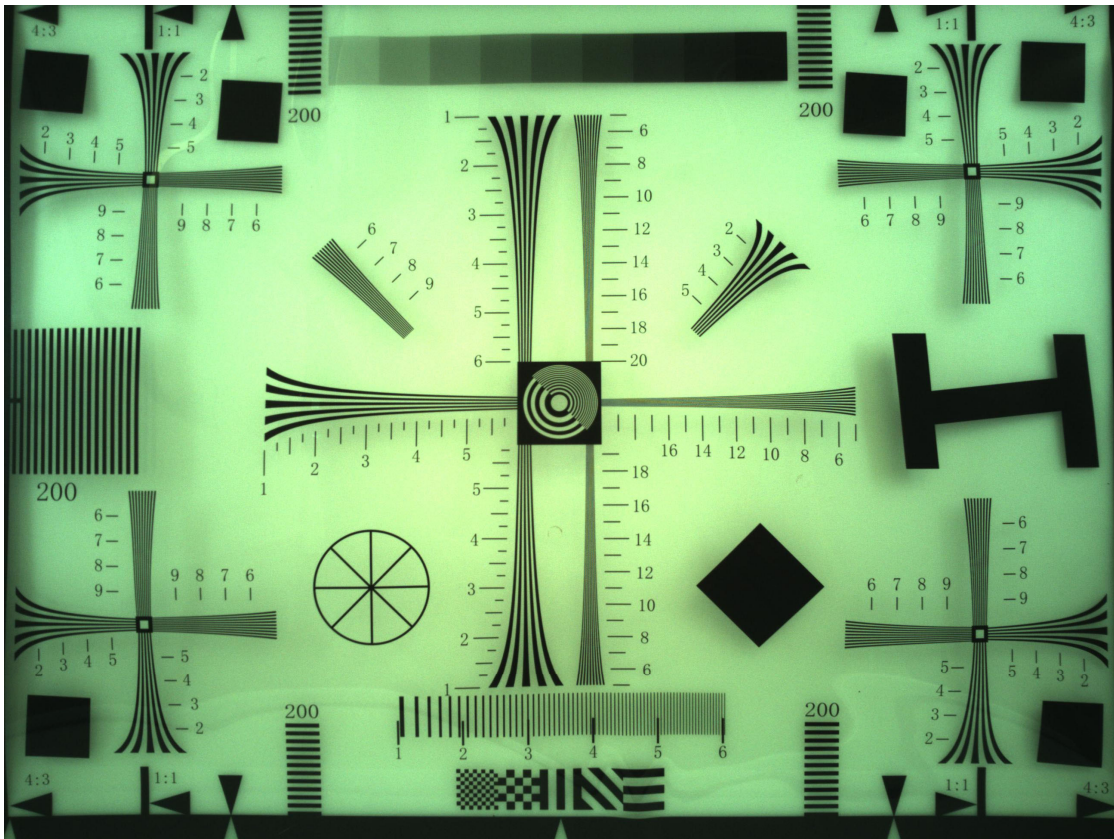


Bottom View

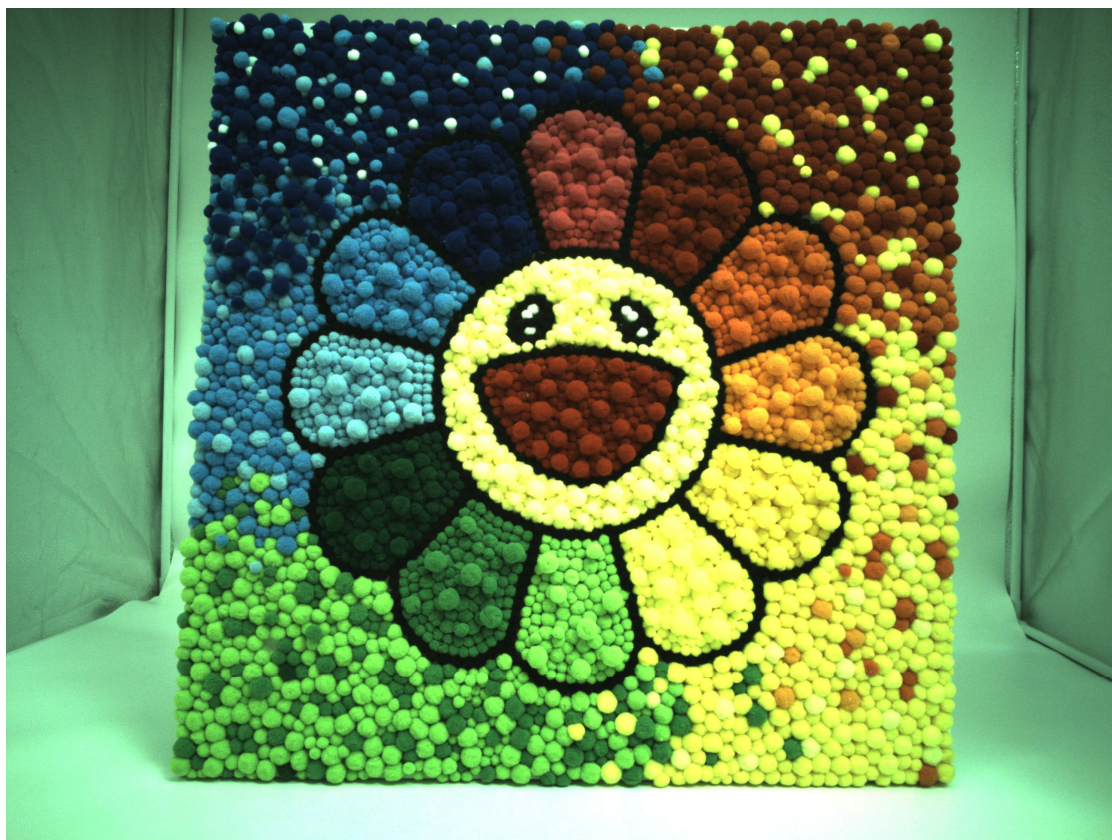


Mating Connector

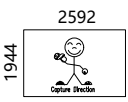
Real Test Images KG7-V3F V4.2



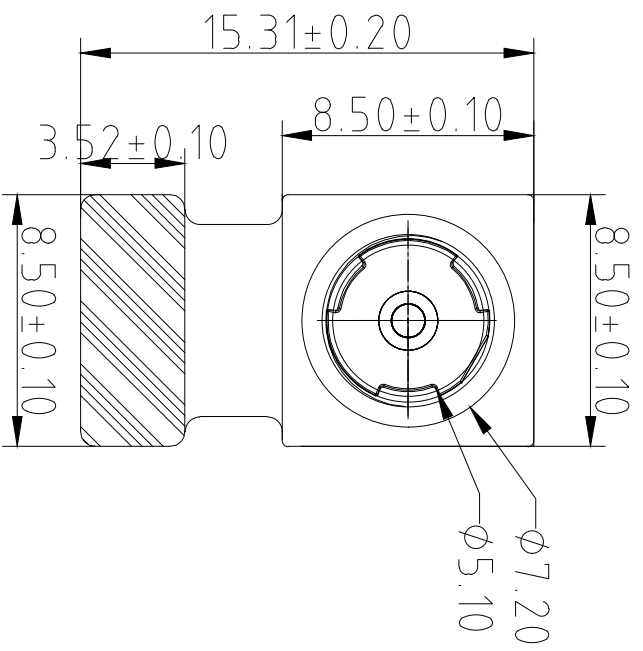
Real Test Images
KG7-V3F V4.2



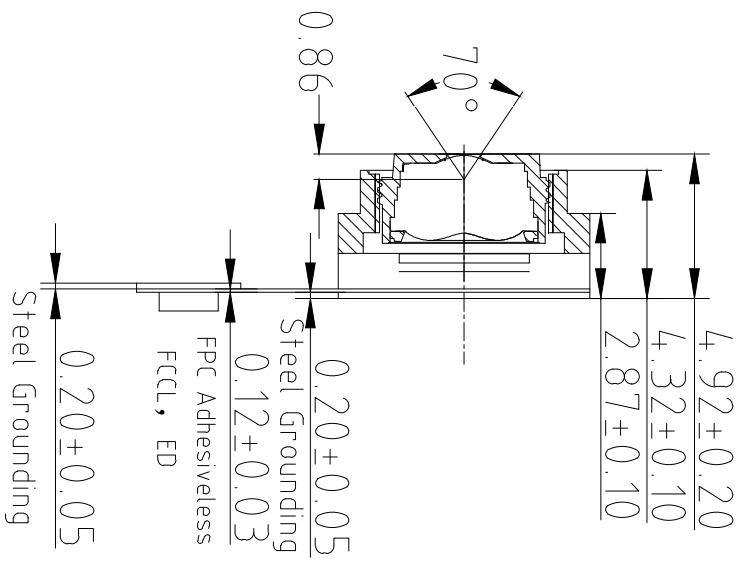
Version	Information	Date
V4.0	First Version	9-23-2020
V4.2	Change lens	9-7-2021



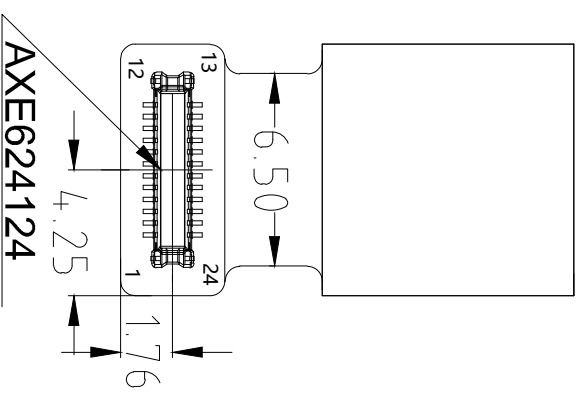
No.	ROHS
1	DGND
2	DGND
3	SDA
4	AVDD 2.8V
5	SCL
6	RESET
7	DGND
8	PWDN
9	DGND
10	DVDD 1.5V
11	DOVDD 1.8V
12	NC
13	MCLK
14	DGND
15	DGND
16	MCN
17	MCP
18	DGND
19	MDN0
20	MDP0
21	DGND
22	MDN1
23	MDP1
24	DGND



TOP VIEW



SIDE VIEW



BOTTOM VIEW

Parameter:

1、Sensor specification:

Image Sensor: OV5648
 Pixel: 1.4umx1.4um
 Lens Type: 1/4
 Important Voltage Description: DVDD1.5V
 (external power supply);

2、Lens specification:

FOV: 70°
 F/NO.: 2.8
 TV distortion: <1.0%
 Focal length: 3.2mm
 Composition: 4P+IR FILTER
 IR Cut Coating: 650nm±10nm@50%

Designed By

Kevin

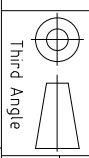
Model Name:

KG7-V3F V4.2

Checked By

Aouly_Yan

Projection Type:



Unit:

mm

Material:

Scale:

1:1

Sheet:

1 of 1

Version:

1/0

A

B

C

D

E

3

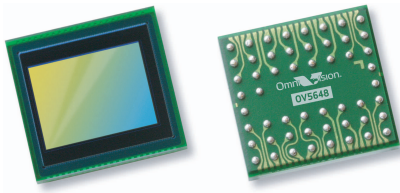
3

2

2

1

1



OV5648 5-megapixel product brief



Cost-Efficient 5-Megapixel Camera Solution for Mainstream Mobile Devices



available in
a lead-free
package

The OV5648 is a cost-efficient, high performance 5-megapixel CameraChip™ sensor for smartphones and tablets. Utilizing OmniVision's latest 1.4-micron OmniBSI+™ pixel architecture, the OV5648 combines a reduced die size with improved quality photography and high-definition (HD) video, making it ideally suited for mainstream mobile applications.

OmniVision's powerful new OmniBSI+ pixel architecture offers significant performance improvements over our original OmniBSI™ architecture, including a 60 percent increase in full-well capacity and a significant improvement in low-light sensitivity. With OmniBSI+, the 1/4-inch OV5648 is capable of capturing high quality still images as well as 720p HD video at 60 frames per second (fps) and 1080p HD video at 30 fps.

The sensor supports a two-lane MIPI interface, and provides full-frame, windowed or binned 10-bit images in RAW RGB format with complete user control over

formatting and output transfer. It offers defective pixel canceling and all required automatic image control functions, including automatic exposure control, automatic gain control, automatic white balance, and automatic black level calibration.

A secondary image sensor may be connected to the OV5648 enabling a Video-in-Video (ViV) feature in which the secondary image is overlaid to the OV5648 output video. The combined video is streamed out over the MIPI interface. A bypass mode allows a secondary sensor to utilize the OV5648 MIPI interfaced baseband.

The OV5648 can fit into a 6 x 6 mm fixed focus camera module with a z-height of less than 4.5 mm.

Find out more at www.ovt.com.

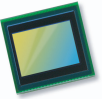
Applications

- Cellular and Picture Phones
- PC Multimedia
- Toys
- Digital Still Cameras

Product Features

- 1.4 μm x 1.4 μm pixel with OmniBSI™ technology for high performance (high sensitivity, low crosstalk, low noise)
- optical size of 1/4"
- automatic image control functions:
 - automatic exposure control (AEC)
 - automatic gain control (AGC)
 - automatic white balance (AWB)
 - automatic black level calibration (ABLC)
- programmable controls for frame rate, AEC/AGC 16-zone size/position/weight control, mirror and flip, cropping, windowing, and panning
- defective pixel canceling
- support for output formats: 8-/10-bit raw RGB data
- support for video or snapshot operations
- support for LED and flash strobe mode
- support for internal and external frame synchronization for frame exposure mode
- support for horizontal and vertical sub-sampling
- standard serial SCCB interface
- MIPI interface (two lanes)
- Video-in-Video (ViV) and bypass support for secondary sensor
- 32 bytes of embedded one-time programmable (OTP) memory
- on-chip phase lock loop (PLL)
- embedded 1.5V regulator for core power
- programmable I/O drive capability, I/O tri-state configurability
- support for black sun cancellation

OV5648



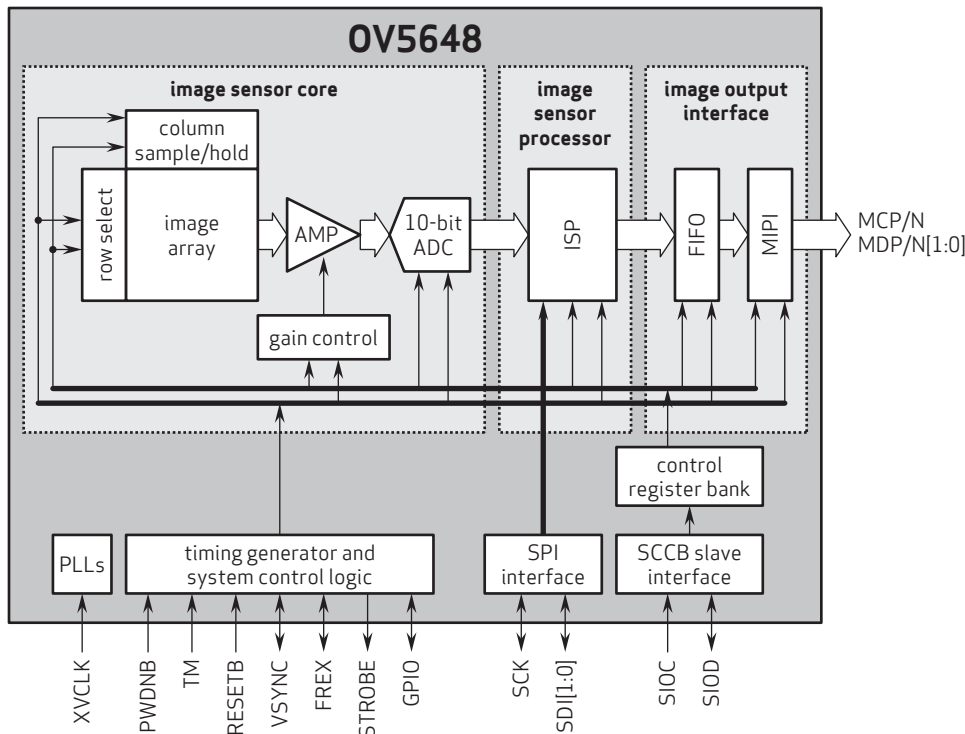
Ordering Information

- OV05648-A53A**
(color, lead-free, 53-pin CSP3)
- OV05648-G04A**
(color, chip-probing, 200 μm backgrinding, reconstructed wafer)

Product Specifications

- active array size:** 2592 x 1944
- max S/N ratio:** 36 dB
- power supply:**
 - core: 1.5V \pm 5% (with embedded 1.5V regulator)
 - analog: 2.6 - 3.0V (2.8V typical)
 - I/O: 1.7 - 3.0V
- dynamic range:** 72 dB @ 8x gain
- power requirements:**
 - active: 219 mW
 - standby: 36 μW
- temperature range:**
 - operating: -30°C to 70°C junction temperature
 - stable image: 0°C to 50°C junction temperature
- shutter:** rolling shutter
- output formats:** 8-/10-bit RGB RAW output
- pixel size:** 1.4 μm x 1.4 μm
- lens size:** 1/4"
- lens chief ray angle:** 29.1°
- input clock frequency:** 6 - 27 MHz
- maximum image transfer rate:**
 - QSVGA (2592x1944): 15 fps
 - 1080p: 30 fps
 - 960p: 45 fps
 - 720p: 60 fps
 - VGA (640x480): 90 fps
- sensitivity:** 690 mV/lux-sec
- dark current:** 0.7 mV/s @ 50°C junction temperature
- image area:** 3673.6 μm x 2738.4 μm
- package/die dimensions:**
 - CSP3: 5010 μm x 4810 μm
 - COB: 5000 μm x 4800 μm

Functional Block Diagram



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USA

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Fax: +1 408 567 3001
www.ovt.com

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OmniVision

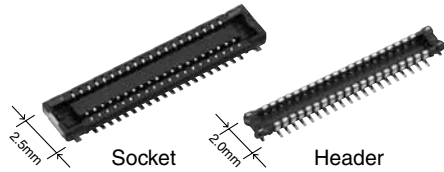
YDS-LENS-M5182

SPECIFICATION	
1. SENSOR SIZE	1/4" (5M COB)
2. MAX IMAGE CIRCLE	$\phi 4.85\text{mm}$
3. TOTAL TRACK	4.0±0.1mm
4. EFL	3.2mm
5. OPTICAL EFL	1.32mm
6. MECHANICAL EFL	0.98mm
7. F/NO	2.8=5f
8. VIEW OR FIELD DIAGONAL	45.3° (Y=1.36) 58.6° (Y=1.81) 70.0° (Y=2.26)
9. OPTICAL DISTORTION	<1.0%
10. TV DISTORTION	<1.0%
11. RELATIVE ILLUMINATION	>42.2%
12. CONSTRUCTION	4P
13. CHIEF RAY ANGLE	<25°
14. CUT FREQUENCY AT 50%	\
15. THREAD	M6.0X0.35P
16. IMAGE QUALITY	AXIS 330lp/mm
17. APPEARANCE QUALITY (Scratch/Dirt)	0.7Y 200Lp/mm CENTER 20/lc

NO	MODIFY CONTENT	NAME	DATE	ANGLE	RANGE	DIM	UNIT	SCALE	REVISION	DATE	REMARK
1	增加规格书5.35G/A.35H/95.59 (CV.010)	tonlin	2016-12-05	X.XX	±0.05	mm	mm	10:1	APPROVED	2016-12-05	

NOTE:

- 镜头表面不可有油污、灰尘、毛丝等异物。
- 镜头配VCM锁附高度为 4.2±0.1mm, 扭力为20--120gf.cm。
- 镜头承受推力为≥2.0kg。
- 镜头组品质参数需符合图中要求。



RoHS compliant

FEATURES

1. 2.5 mm wide slim two-piece style connectors

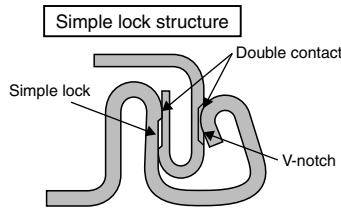
Compact and slim structure contributes overall miniaturization of product design. <Compared to F4S series (40 pin contacts, when mated)>

- Width: 30% down
- Footprint: 30% down



2. **"TOUGH CONTACT ADVANCED"** ensures high resistance to various environments in lieu of slim and low profile body

3. Simple lock structure provides tactile feedback to ensure excellent mating/unmating operation feel.



The connector gives the tactile feedback when inserted, allowing reliable mating.

- 4. Mated heights of 0.8 and 1.0 mm are available for the same foot pattern.
- 5. Connectors for inspection available

APPLICATIONS

Recommended for board-to-FPC connections of mobile equipment, such as cellular phones, smart phones, laptops, and portable music players

ORDERING INFORMATION

	AXE				2	4
5: Narrow Pitch Connector A4S (0.4 mm pitch) Socket						
6: Narrow Pitch Connector A4S (0.4 mm pitch) Header						
Number of pins (2 digits)						
Mated height						
<Socket>						
1: For mated height 0.8/1.0 mm						
<Header>						
1: For mated height 0.8 mm						
2: For mated height 1.0 mm						
Functions						
2: Without positioning bosses						
Surface treatment (Contact portion / Terminal portion)						
<Socket>						
4: Ni plating on base, Au plating on surface (for Ni barrier available)						
<Header>						
4: Ni plating on base, Au plating on surface						

PRODUCT TYPES

Mated height	Number of pins	Part number		Packing	
		Socket	Header	Inner carton (1-reel)	Outer carton
0.8mm	10	AXE510124	AXE610124	5,000 pieces	10,000 pieces
	12	AXE512124	AXE612124		
	14	AXE514124	AXE614124		
	16	AXE516124	AXE616124		
	18	AXE518124	AXE618124		
	20	AXE520124	AXE620124		
	22	AXE522124	AXE622124		
	24	AXE524124	AXE624124		
	26	AXE526124	AXE626124		
	28	AXE528124	AXE628124		
	30	AXE530124	AXE630124		
	32	AXE532124	AXE632124		
	34	AXE534124	AXE634124		
	36	AXE536124	AXE636124		
	38	AXE538124	AXE638124		
	40	AXE540124	AXE640124		
	44	AXE544124	AXE644124		
	50	AXE550124	AXE650124		
	54	AXE554124	AXE654124		
	1.0mm	56	AXE556124		
60		AXE560124	AXE660124		
64		AXE564124	AXE664124		
70		AXE570124	AXE670124		
80		AXE580124	AXE680124		
10		AXE510124	AXE610224		
12		AXE512124	AXE612224		
14		AXE514124	AXE614224		
20		AXE520124	AXE620224		
24		AXE524124	AXE624224		
26		AXE526124	AXE626224		
30		AXE530124	AXE630224		
32		AXE532124	AXE632224		
40		AXE540124	AXE640224		
44	AXE544124	AXE644224			
50	AXE550124	AXE650224			
54	AXE554124	AXE654224			
60	AXE560124	AXE660224			
70	AXE570124	AXE670224			
80	AXE580124	AXE680224			

- Notes: 1. Order unit:
 For volume production: 1-inner carton (1-reel) units
 Samples for mounting check: 50-connector units. Please contact our sales office.
 Samples: Small lot orders are possible. Please contact our sales office.
2. The above part numbers are for connectors without positioning bosses, which are standard. When ordering connectors with positioning bosses, please contact our sales office.
3. Please contact us for connectors having a number of pins other than those listed above.

AXE5, 6

SPECIFICATIONS

■ Characteristics

	Item	Specifications	Conditions
Electrical characteristics	Rated current	0.3A/pin contact (Max. 5 A at total pin contacts)	
	Rated voltage	60V AC/DC	
	Breakdown voltage	150V AC for 1 min.	No short-circuiting or damage at a detection current of 1 mA when the specified voltage is applied for one minute.
	Insulation resistance	Min. 1,000MΩ (initial)	Using 250V DC megger (applied for 1 min.)
	Contact resistance	Max. 90mΩ	Based on the contact resistance measurement method specified by JIS C 5402.
Mechanical characteristics	Composite insertion force	Max. 1.200N/pin contacts × pin contacts (initial)	
	Composite removal force	Min. 0.165N/pin contacts × pin contacts	
Environmental characteristics	Contact holding force (Socket contact)	Min. 0.20N/pin contacts	Measuring the maximum force. As the contact is axially pull out.
	Ambient temperature	-55°C to +85°C	No freezing at low temperatures. No dew condensation.
	Soldering heat resistance	Peak temperature: 260°C or less (on the surface of the PC board around the connector terminals) 300°C within 5 sec. 350°C within 3 sec.	Infrared reflow soldering Soldering iron
	Storage temperature	-55°C to +85°C (product only) -40°C to +50°C (emboss packing)	No freezing at low temperatures. No dew condensation.
	Thermal shock resistance (header and socket mated)	5 cycles, insulation resistance min. 100MΩ, contact resistance max. 90mΩ	Sequence 1. -55 ^{±3} °C, 30 minutes 2. ~, Max. 5 minutes 3. 85 ^{±3} °C, 30 minutes 4. ~, Max. 5 minutes
	Humidity resistance (header and socket mated)	120 hours, insulation resistance min. 100MΩ, contact resistance max. 90mΩ	Bath temperature 40±2°C, humidity 90 to 95% R.H.
	Saltwater spray resistance (header and socket mated)	24 hours, insulation resistance min. 100MΩ, contact resistance max. 90mΩ	Bath temperature 35±2°C, saltwater concentration 5±1%
H ₂ S resistance (header and socket mated)	48 hours, contact resistance max. 90mΩ	Bath temperature 40±2°C, gas concentration 3±1 ppm, humidity 75 to 80% R.H.	
Lifetime characteristics	Insertion and removal life	30 times	Repeated insertion and removal speed of max. 200 times/hours
Unit weight		20 pin contact type: Socket: 0.02 g Header: 0.01 g	

■ Material and surface treatment

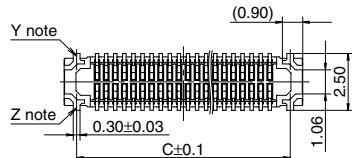
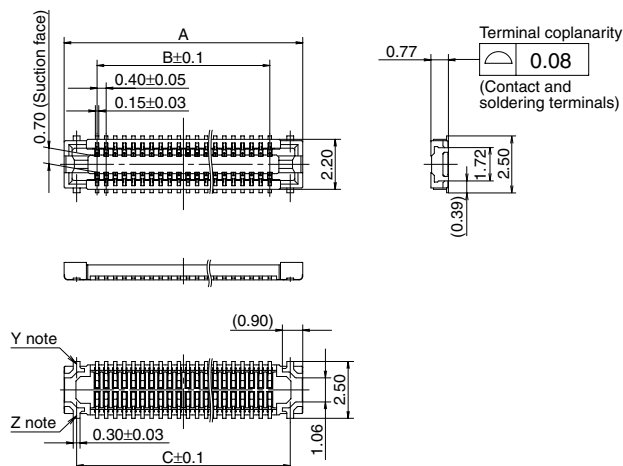
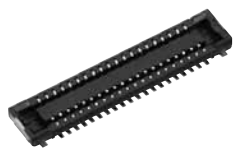
Part name	Material	Surface treatment
Molded portion	LCP resin (UL94V-0)	—
Contact and Post	Copper alloy	Contact portion: Base: Ni plating Surface: Au plating Terminal portion: Base: Ni plating Surface: Au plating (except the terminal tips) The socket terminals close to the portion to be soldered have nickel barriers (exposed nickel portions). Soldering terminals: Sockets: Base: Ni plating Surface: Pd+Au flash plating (except the terminal tips) Headers: Base: Ni plating Surface: Au plating (except the terminal tips)

DIMENSIONS (Unit: mm)

The CAD data of the products with a **CAD Data** mark can be downloaded from: <http://industrial.panasonic.com/ac/e>

■ **Socket (Mated height: 0.8 mm/1.0 mm)**

CAD Data



General tolerance: ±0.2

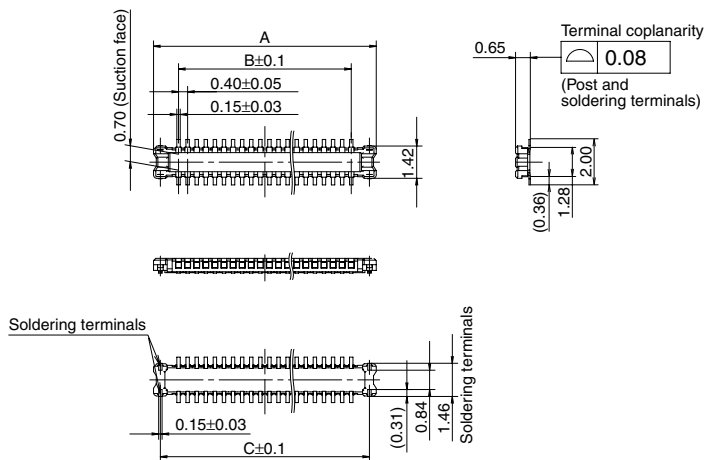
Note: Since the soldering terminals has a single-piece construction, sections Y and Z are electrically connected.

Dimension table (mm)

Number of pins/dimension	A	B	C
10	4.5	1.6	3.4
12	4.9	2.0	3.8
14	5.3	2.4	4.2
16	5.7	2.8	4.6
18	6.1	3.2	5.0
20	6.5	3.6	5.4
22	6.9	4.0	5.8
24	7.3	4.4	6.2
26	7.7	4.8	6.6
28	8.1	5.2	7.0
30	8.5	5.6	7.4
32	8.9	6.0	7.8
34	9.3	6.4	8.2
36	9.7	6.8	8.6
38	10.1	7.2	9.0
40	10.5	7.6	9.4
44	11.3	8.4	10.2
50	12.5	9.6	11.4
54	13.3	10.4	12.2
56	13.7	10.8	12.6
60	14.5	11.6	13.4
64	15.3	12.4	14.2
70	16.5	13.6	15.4
80	18.5	15.6	17.4

■ **Header (Mated height: 0.8 mm)**

CAD Data



General tolerance: ±0.2

Dimension table (mm)

Number of pins/dimension	A	B	C
10	3.8	1.6	3.2
12	4.2	2.0	3.6
14	4.6	2.4	4.0
16	5.0	2.8	4.4
18	5.4	3.2	4.8
20	5.8	3.6	5.2
22	6.2	4.0	5.6
24	6.6	4.4	6.0
26	7.0	4.8	6.4
28	7.4	5.2	6.8
30	7.8	5.6	7.2
32	8.2	6.0	7.6
34	8.6	6.4	8.0
36	9.0	6.8	8.4
38	9.4	7.2	8.8
40	9.8	7.6	9.2
44	10.6	8.4	10.0
50	11.8	9.6	11.2
54	12.6	10.4	12.0
56	13.0	10.8	12.4
60	13.8	11.6	13.2
64	14.6	12.4	14.0
70	15.8	13.6	15.2
80	17.8	15.6	17.2



YDS CAMERA MODULE

your best camera partner

Camera Module Pinout Definition Reference Chart

OmniVision	Sony	Samsung	On-Semi	Aptina	Himax	GalaxyCore	PixArt	SmartSens	Sensors
Pin Signal		Description							
DGND	GND	ground for digital circuit							
AGND		ground for analog circuit							
PCLK	DCK	DVP PCLK output							
XCLR	PWDN	XSHUTDOWN	STANDBY	power down active high with internal pull-down resistor					
MCLK	XVCLK	XCLK	INCK	system input clock					
RESET	RST	reset active low with internal pull-up resistor							
NC	NULL	no connect							
SDA	SIO_D	SIOD	SCCB data						
SCL	SIO_C	SIOC	SCCB input clock						
VSYNC	XVS	FSYNC	DVP VSYNC output						
HREF	XHS	DVP HREF output							
DOVDD	power for I/O circuit								
AFVDD	power for VCM circuit								
AVDD	power for analog circuit								
DVDD	power for digital circuit								
STROBE	FSTROBE	strobe output							
FSIN	synchronize the VSYNC signal from the other sensor								
SID	SCCB last bit ID input								
ILPWM	mechanical shutter output indicator								
FREX	frame exposure / mechanical shutter								
GPIO	general purpose inputs								
SLASEL	I2C slave address select								
AFEN	CEN chip enable active high on VCM driver IC								
MIPI Interface									
MDN0	DN0	MD0N	DATA_N	DMO1N	MIPI 1st data lane negative output				
MDP0	DP0	MD0P	DATA_P	DMO1P	MIPI 1st data lane positive output				
MDN1	DN1	MD1N	DATA2_N	DMO2N	MIPI 2nd data lane negative output				
MDP1	DP1	MD1P	DATA2_P	DMO2P	MIPI 2nd data lane positive output				
MDN2	DN2	MD2N	DATA3_N	DMO3N	MIPI 3rd data lane negative output				
MDP2	DP2	MD2P	DATA3_P	DMO3P	MIPI 3rd data lane positive output				
MDN3	DN3	MD3N	DATA4_N	DMO4N	MIPI 4th data lane negative output				
MDP3	DP3	MD3P	DATA4_P	DMO4P	MIPI 4th data lane positive output				
MCN	CLKN	CLK_N	DCKN	MIPI clock negative output					
MCP	CLKP	MCP	CLK_P	DCKN	MIPI clock positive output				
DVP Parallel Interface									
D0	DO0	Y0	DVP data output port 0						
D1	DO1	Y1	DVP data output port 1						
D2	DO2	Y2	DVP data output port 2						
D3	DO3	Y3	DVP data output port 3						
D4	DO4	Y4	DVP data output port 4						
D5	DO5	Y5	DVP data output port 5						
D6	DO6	Y6	DVP data output port 6						
D7	DO7	Y7	DVP data output port 7						
D8	DO8	Y8	DVP data output port 8						
D9	DO9	Y9	DVP data output port 9						
D10	DO10	Y10	DVP data output port 10						
D11	DO11	Y11	DVP data output port 11						

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Cameras Applications



IMAGING DEVICES



Camera Reliability Test

Reliability Inspection Item		Testing Method	Acceptance Criteria	
Category	Item			
Environmental	Storage Temperature	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation
	Operation Temperature	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation
	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation
Physical	Drop Test (Free Falling)	Without Package 60cm	10 Times on Wood Floor	Electrically Functional
		With Package 60cm	10 Times on Wood Floor	Electrically Functional
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional
	Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional
Electrical	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional
		Air Discharge 4 KV	ESD Testing Machine	Electrically Functional
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional



Camera Inspection Standard

Inspection Item		Inspection Method	Standard of Inspection		
Category	Item				
Appearance	FPC/ PCB	Color	The Naked Eye	Major Difference is Not Allowed.	
		Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.	
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)	
	Holder	Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed	
		Gap	The Naked Eye	Meet the Height Standard	
		Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)	
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed	
	Lens	Scratch	The Naked Eye	No Effect On Resolution Standard	
		Contamination	The Naked Eye	No Effect On Resolution Standard	
		Oil Film	The Naked Eye	No Effect On Resolution Standard	
		Cover Tape	The Naked Eye	No Issue On Appearance.	
	Function	Image	No Communication	Test Board	Not Allowed
			Bright Pixel	Black Board	Not Allowed In the Image Center
Dark Pixel			White board	Not Allowed In the Image Center	
Blurry			The Naked Eye	Not Allowed	
No Image			The Naked Eye	Not Allowed	
Vertical Line			The Naked Eye	Not Allowed	
Horizontal Line			The Naked Eye	Not Allowed	
Light Leakage			The Naked Eye	Not Allowed	
Blinking Image			The Naked Eye	Not Allowed	
Bruise			Inspection Jig	Not Allowed	
Resolution			Chart	Follows Outgoing Inspection Chart Standard	
Color			The Naked Eye	No Issue	
Noise			The Naked Eye	Not Allowed	
Corner Dark			The Naked Eye	Less Than 100px By 100px	
Color Resolution			The Naked Eye	No Issue	
Dimension	Height	The Naked Eye	Follows Approval Data Sheet		
	Width	The Naked Eye	Follows Approval Data Sheet		
	Length	The Naked Eye	Follows Approval Data Sheet		
	Overall	The Naked Eye	Follows Approval Data Sheet		

YDSCAM Package Solutions

YDS Camera Module



Complete with Lens Protection Film



Tray with Grid and Space



Place Cameras on the Tray

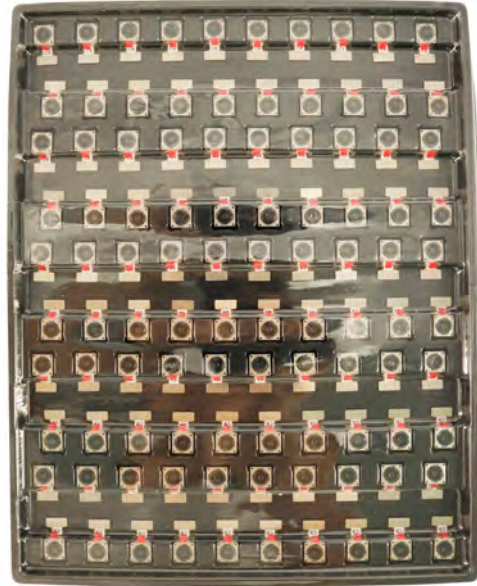


YDSCAM Package Solutions

Full Tray of Cameras



Cover Tray with Lid



Place Tray into Anti-Static Bag



Vacuum the Anti-Static Bag



YDSCAM Package Solutions

Sealed Vacuum Anti-Static Bag with Labels

1. Model and Description 2. Quantity 3. Manufacturing Date Code 4. Caution



YDSCAM Package Solutions

Place Foam Sheets Between Tray Bags



Foam Sheets are Larger Than Trays



Place Foam Sheets and Trays into Box



Foam Sheets are Tightly Fitting in Box



Seal the Carbon Box



Label the Carbon Shipping Box





YDSCAM Package Solutions

USB Camera Module

Complete with Lens Protection Film



Place Camera Sample into Anti-Static Bag

Place USB Cameras into Tray



Seal the Tray with Anti-Static Bag

Label the Carbon Shipping Box



YDSCAM Package Solutions

Place Camera Sample into Anti-Static Bag



Place Connectors into Anti-Static Bag



Label the Sample Bags



Place Connectors into Reel



Place Samples into the Carbon Box



Place Connectors into the Carbon Box





YDS CAMERA MODULE

your best camera partner

Company YDSCAM

YingDeShun Co. Ltd. (YDS) was established in 2017, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. YDS is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

YDS provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. YDS specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



Limited Warranty

YDS provides the following limited warranty if you purchased the Product(s) directly from YDS company or from YDS's website www.YDSCAM.com. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. YDS guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, YDS will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of YDS is solely limited to repair and/or replacement on the terms set forth above. YDS is not reliable or responsible for any subsequent events.



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YDS CAMERA MODULE

your best camera partner

YDS Strength

Powerful Factory



Professional Service



Promised Delivery



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